

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hidehiko Shidara</td> <td>04/10/2008</td> </tr> <tr> <td>Ken Kikuchi</td> <td>04/10/2008</td> </tr> <tr> <td>Yasuo Inoue</td> <td>04/10/2008</td> </tr> <tr> <td>Masahiro Ito</td> <td>04/11/2008</td> </tr> <tr> <td>Hideto Mori</td> <td>04/11/2008</td> </tr> </tbody> </table>		Name	Execution Date	Hidehiko Shidara	04/10/2008	Ken Kikuchi	04/10/2008	Yasuo Inoue	04/10/2008	Masahiro Ito	04/11/2008	Hideto Mori	04/11/2008
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RECEIVING PARTY DATA													
Name:	Sony Corporation												
Street Address:	1-7-1 Konan, Minato-ku												
City:	Tokyo 108-0075												
State/Country:	JAPAN												
PROPERTY NUMBERS Total: 1													
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12120421</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12120421								
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CORRESPONDENCE DATA													
Fax Number:	(312)876-7934												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	3128768000												
Email:	bhannon@sonnenschein.com												
Correspondent Name:	SONNENSCHN NATH & ROSENTHAL LLP												
Address Line 1:	P.O. BOX 061080												
Address Line 2:	WACKER DRIVE STATION, SEARS TOWER												
Address Line 4:	CHICAGO, ILLINOIS 60606-1080												
ATTORNEY DOCKET NUMBER:	09792909-7301												
NAME OF SUBMITTER:	David R. Metzger												
Total Attachments: 2													

OP \$40.00 12120421

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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in DISPLAY DEVICE, DRIVING METHOD AND COMPUTER PROGRAM FOR DISPLAY DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 12/120,421, Filing Date: May 14, 2008.

This assignment executed on the dates indicated below.

Hidehiko SHIDARA
Name of first or sole inventor Execution date of U.S. Patent Application

Tokyo, Japan
Residence of first or sole inventor

Hidehiko Shidara Signature of first or sole inventor April 10, 2008 Date of this assignment

Ken KIKUCHI

Name of second inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of second inventor

Ken Kikuchi

April 10, 2008

Signature of second inventor

Date of this assignment

Yasuo INOUE

Name of third inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of third inventor

Yasuo Inoue

April 10, 2008

Signature of third inventor

Date of this assignment

Masahiro ITO

Name of fourth inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of fourth inventor

Masahiro Ito

April 11, 2008

Signature of fourth inventor

Date of this assignment

Hideto MORI

Name of fifth inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of fifth inventor

Hideto Mori

April 11, 2008

Signature of fifth inventor

Date of this assignment

PATENT

RECORDED: 05/14/2008

REEL: 020946 FRAME: 0128